



FAST READOUT OPTICAL STORAGE TECHNOLOGY (FROST) CONSORTIUM



Contract # F-30602-98-3-0226
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Call/Recall, Inc.

Irvine Sensors Corporation

University of Southern California

Other Participating Institutions:

University of California, Los Angeles

Parallel Solutions, Inc.





Objective:

- to develop and demonstrate VLSI Photonic technologies capable of addressing the limiting bottlenecks in digital optical storage systems.
- to develop a bit-oriented removable optical volumetric disk system with a parallel readout head to demonstrate high-capacity (**50 Gbyte per platter**), and high-throughput (**2 Gb/s sustained user data rate**).

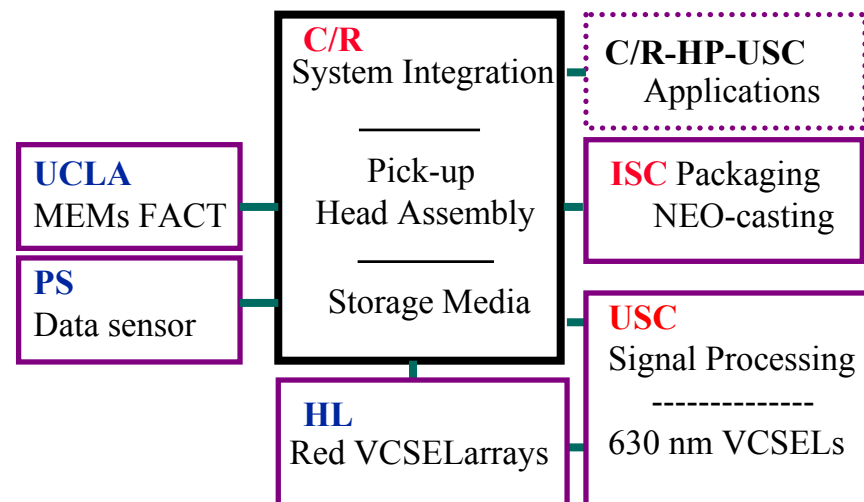
Approach:

Utilize a volumetric disk readout architecture based on

- photochromic polymer storage media,
- VCSEL array,
- 3-D imaging system,
- MEMS optical actuator chip,
- high-performance sensor array,
- parallel channel electronics,
- micro-bench optical packaging.

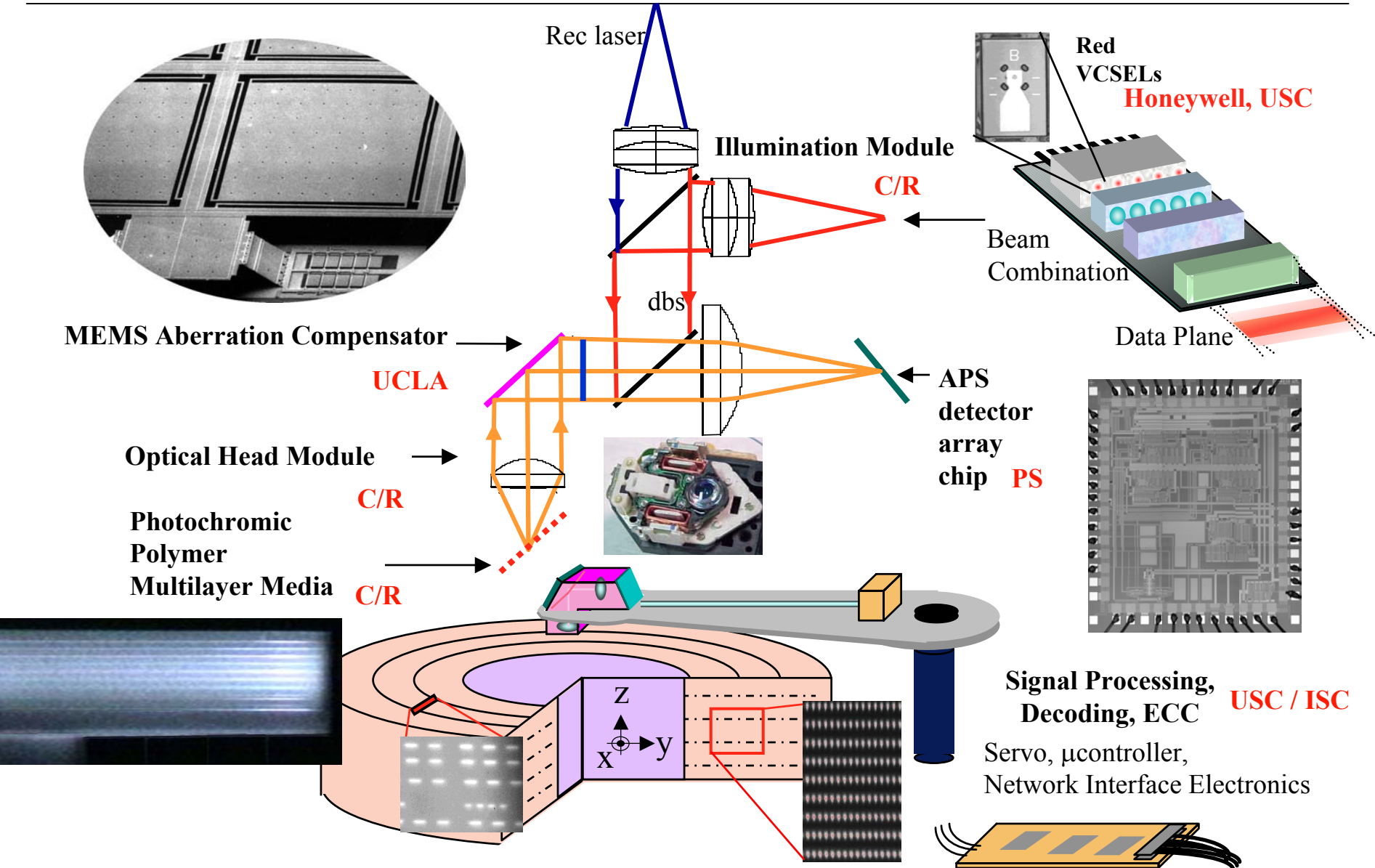
Program Milestones:

1999: Components & Subsystem Designs:
media, VCSELs, receivers, MEMS
2000: Illumination subsystem module
2001: Imaging mod. & Subsystem integration:
Low speed sys. demo
2002: Single supertrack high speed demo
2002: Radial access final demo



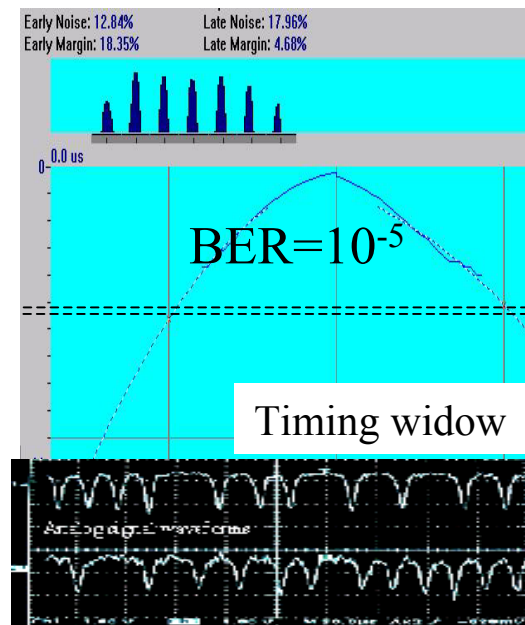
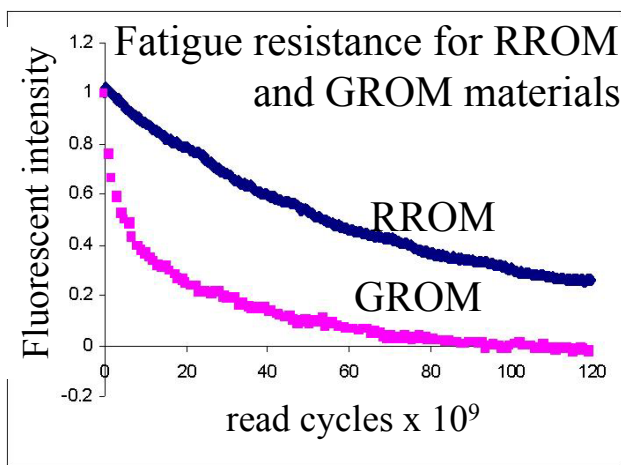
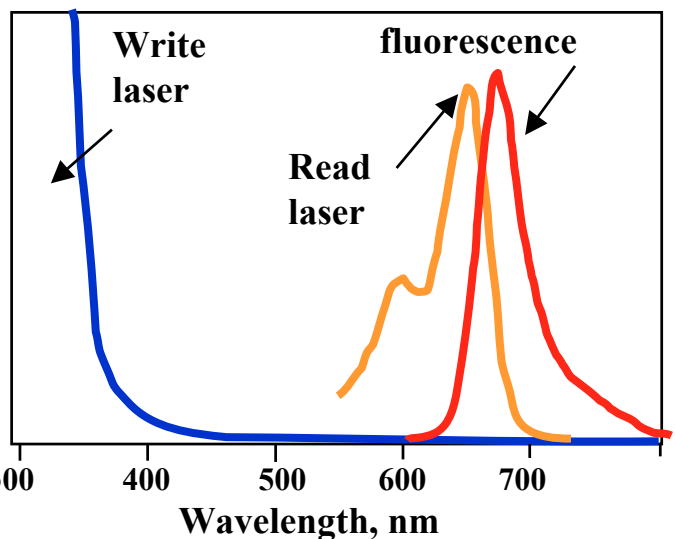
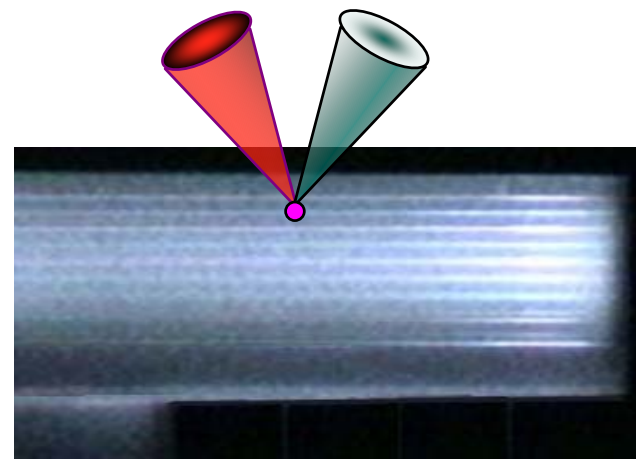
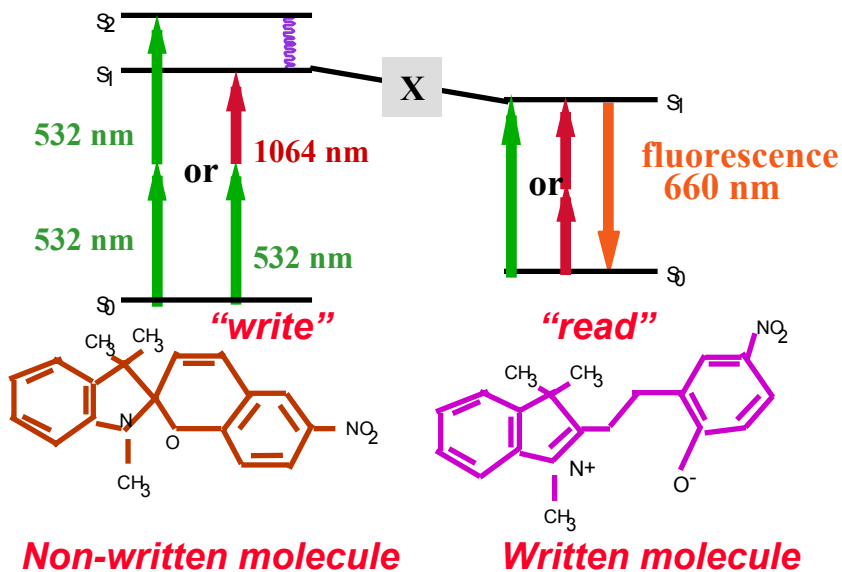


FAST READOUT OPTICAL STORAGE TECHNOLOGY: *Parallel access multilayer optical disk data storage*



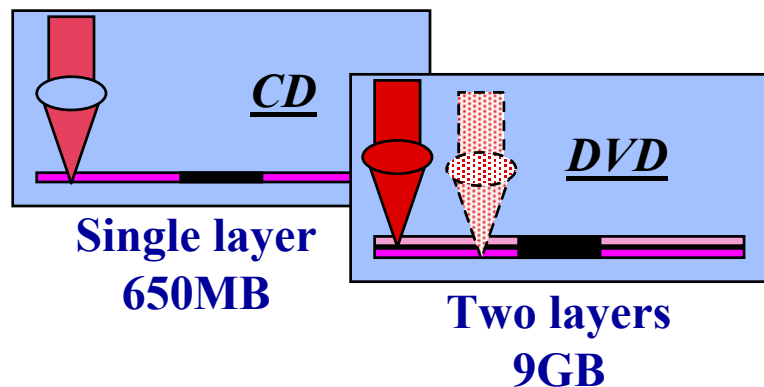


Two-photon sensitive WORM media operation and characteristics





3D Disk Capacity and Data Rate



Blue DVD

$\lambda = 410\text{nm}$

$\text{NA} = 0.85$

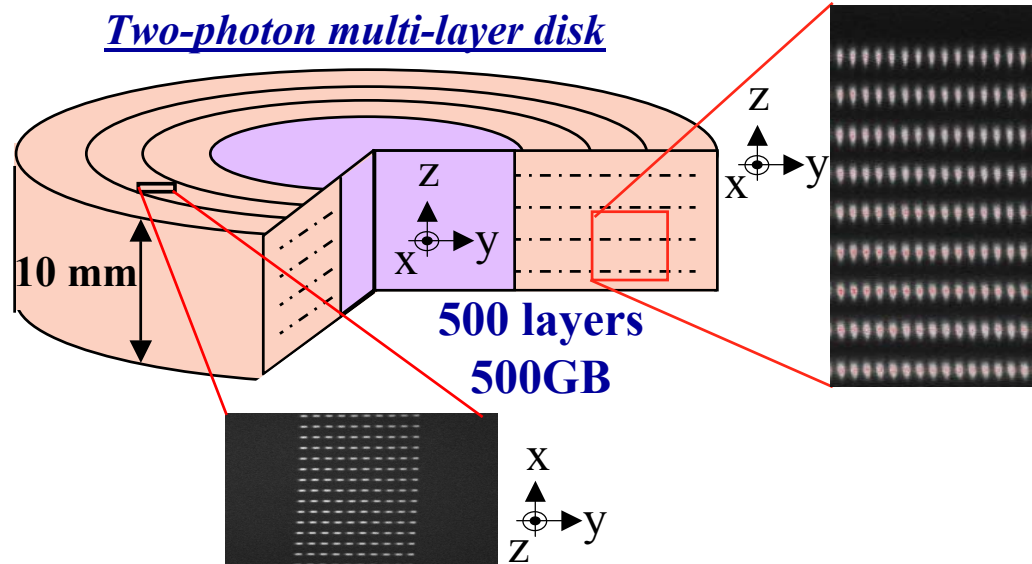
Spot size = $1.22 \lambda / \text{NA} = 0.6 \mu\text{m}$

layers = 2

Layer pitch = $40\text{-}70 \mu\text{m}$

Capacity = 45 GB

Rate = 35 Mb/s



Two-photon (Blue) multi-layer disk

$\lambda = (460\text{nm}) / 635\text{nm (write)/read}$

$\text{NA} = 0.5$

Spot size = $\sim 1 \mu\text{m}$

layers = 500

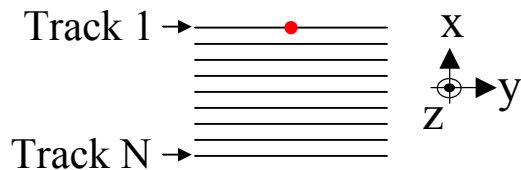
Layer pitch = $20 \mu\text{m}$

Capacity = 500 GB

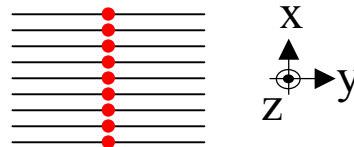
Rate = $(1\text{Mb/s/ch})(1000 \text{ channels}) = 1 \text{ Gb/s}$



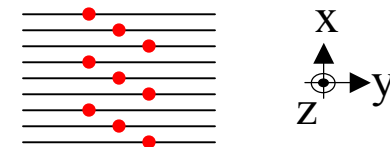
Parallel readout architectures



- **Single spot:**
 - simple, low cost
 - low data rate, large stroke actuator



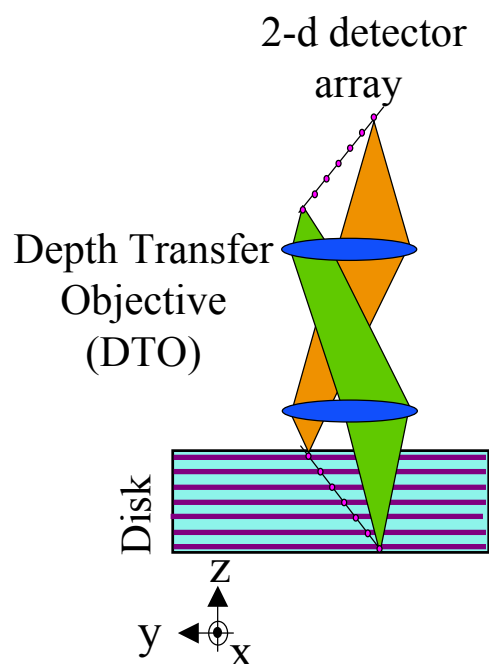
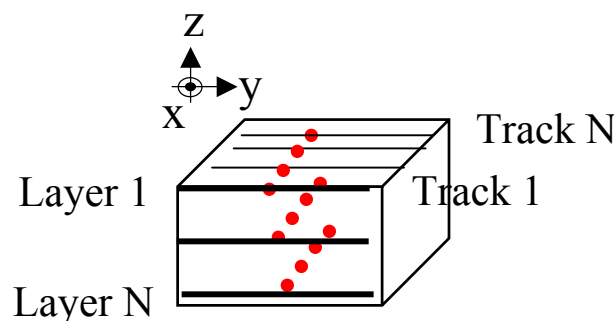
- **1-D array (single layer):**
 - increases transfer rate
 - more complex track/focus
 - poor use of FOV of lens



- **2-D array (single layer):**
 - 1-D issues plus
 - CAV
 - same throughput as 1-D array

2-D array (many layers):

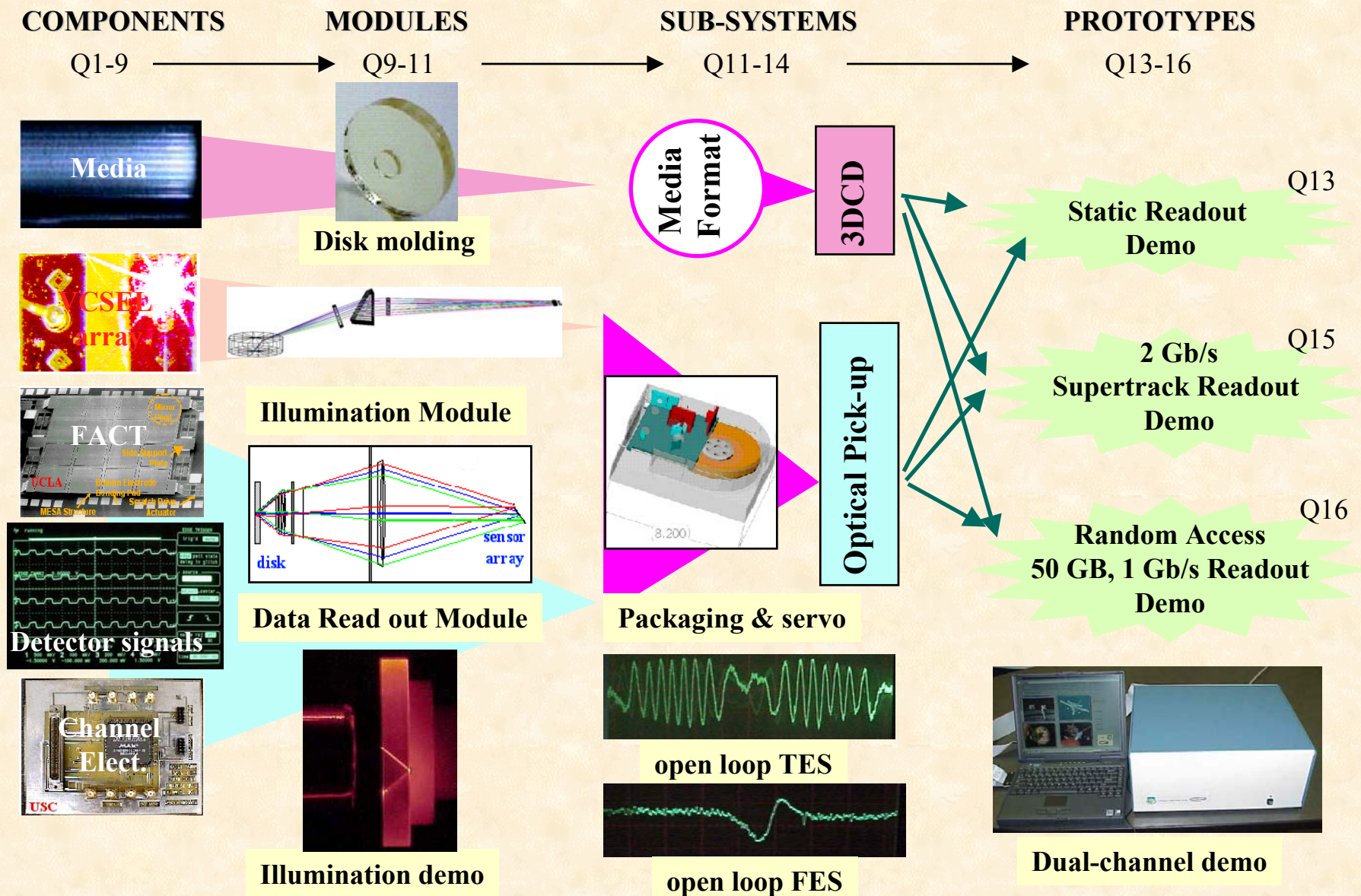
- multi-track/multi-layer readout
- high transfer rate
- BEST use of lens 2-D FOV
- minimizes actuator stroke
- CLV
- More complex track/focus
- 3D media and novel optics



Depth Transfer Objective (DTO):
Doubly telecentric afocal image relay images data plane with constant lateral and longitudinal magnification to the detector array



FROST Program Flow





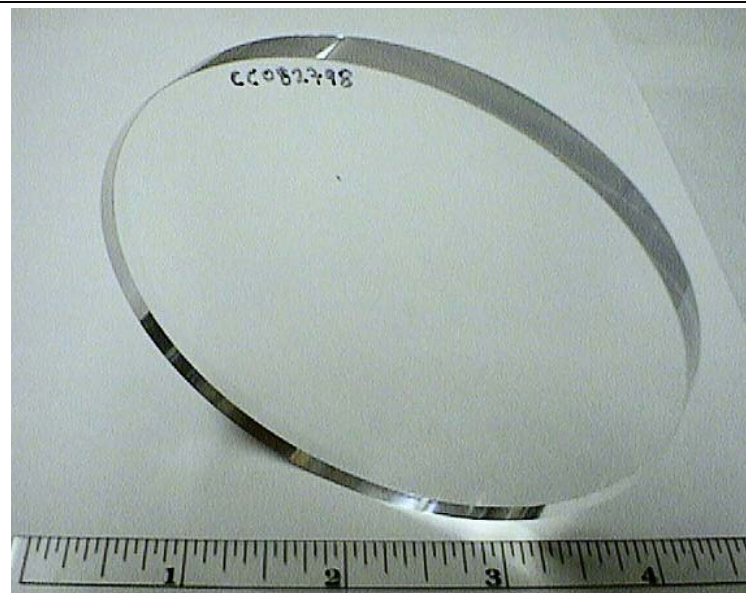
Thick Disk Media



OBJECTIVE

5.25" diameter red readout thick disk media for FROST to achieve

- Read form absorption tuned to red VCSEL wavelengths
- increased sensitivity and improved performance characteristics



APPROACH

- Photochromic-dye-doped polymers
- Volumetric Storage
- Highly efficient fluorescence
- Broad write/read λ -tolerance
- Single beam recording with very closely spaced layers
- Low cost moldable plastics supporting ultra high density media

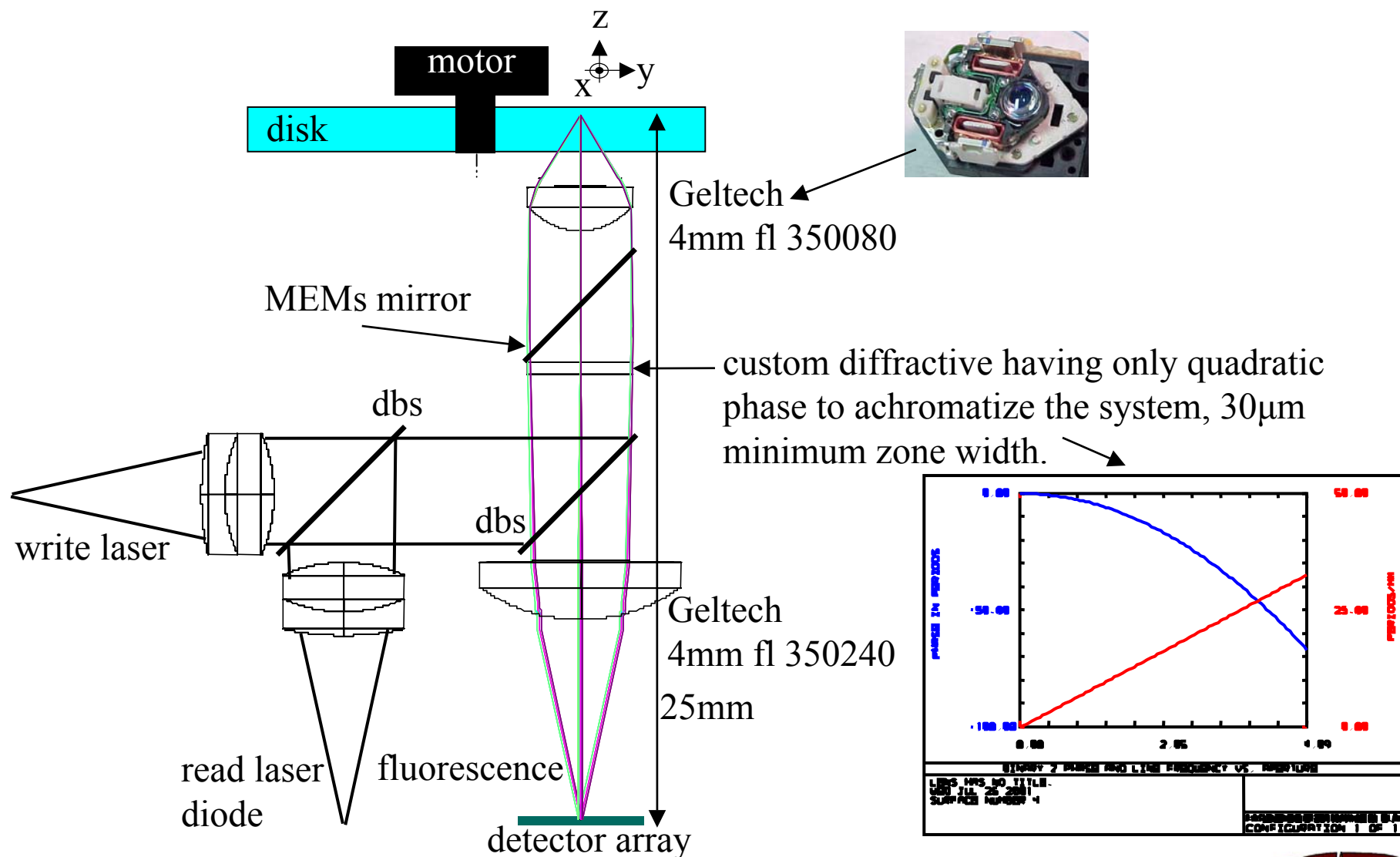
3rd YEAR ACCOMPLISHMENTS

- Readout with red (650nm) diode laser
- 3.5 inch diameter, 5mm thick disks fabricated
- 3X Higher writing efficiency
- 10X Lower background noise
- 3X Higher readout fatigue resistance
- Higher temperature stability





0.53 NA DTO system architecture with collinear recording and illumination paths



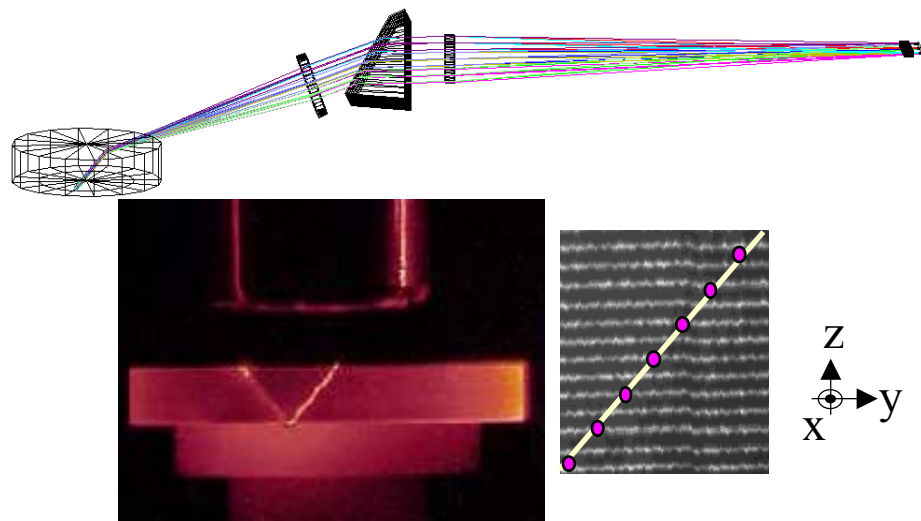


Illumination Module



OBJECTIVE

To illuminate a 2-dimensional data page inside the disk to generate fluorescence from a selected data page containing 1024 data channels



APPROACH

- By combining a 2-d VCSEL array output into a uniform sheet of light.
- By imaging a 2-d VCSEL array to a data page on a point by point basis

3rd YEAR ACCOMPLISHMENTS

- Demonstrated beam sheet of $20\mu\text{m} \times 160\mu\text{m} \times 300\mu\text{m}$
- Demonstrated a 1x16 point by point illumination
- 2-D custom and cots designs completed

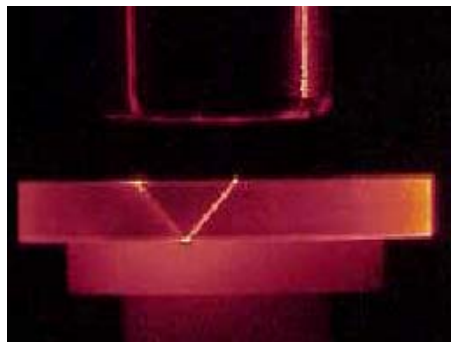
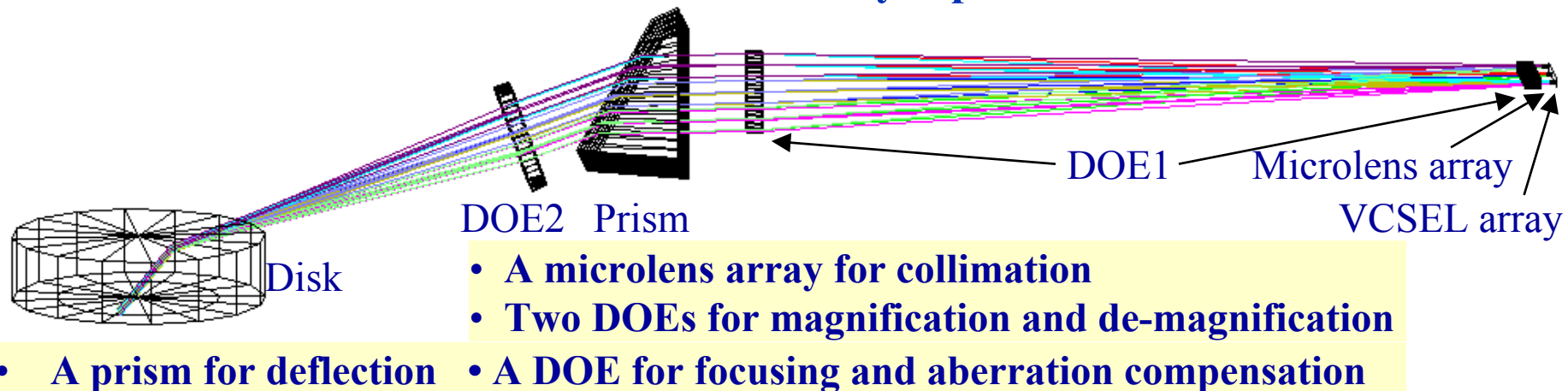




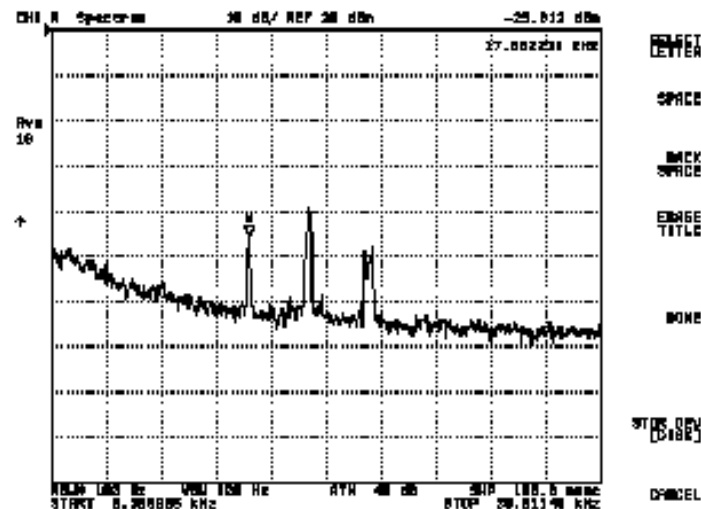
Illumination Module



For multi-track/multi-layer parallel readout



six tracks
(20 μ m interval
at a same depth)



Readout of three tracks
(75 μ m interval along the depth)

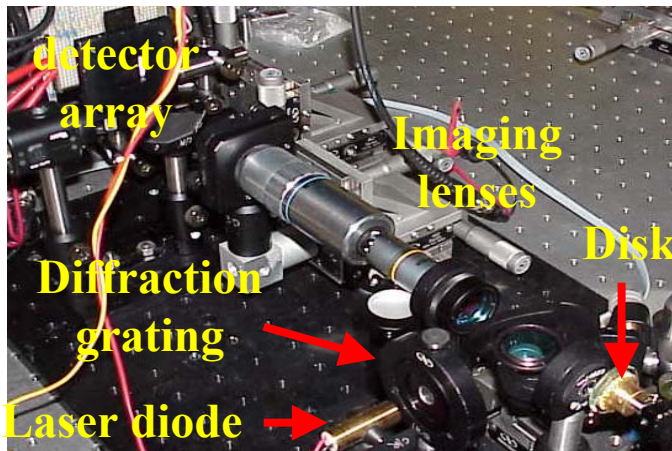
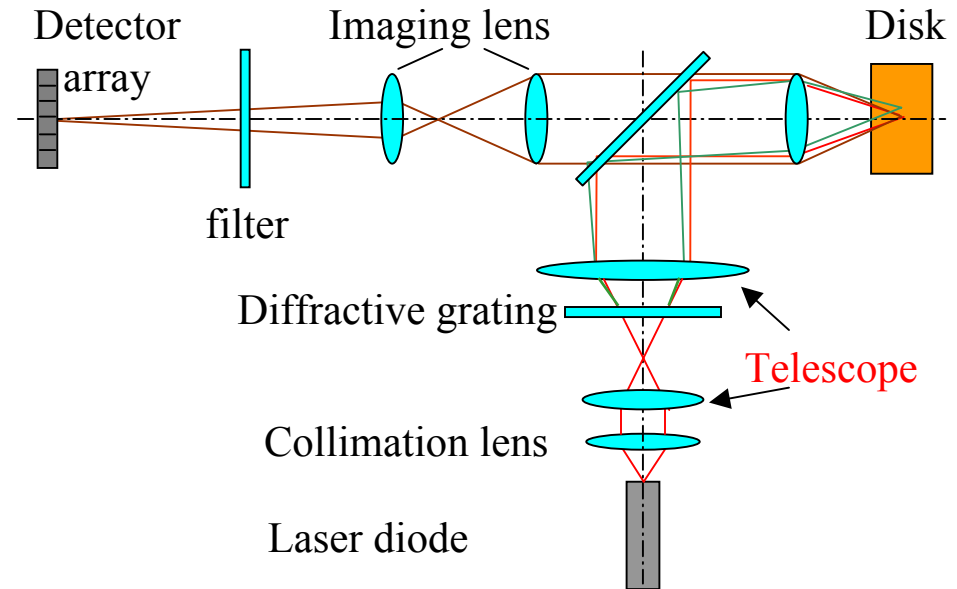
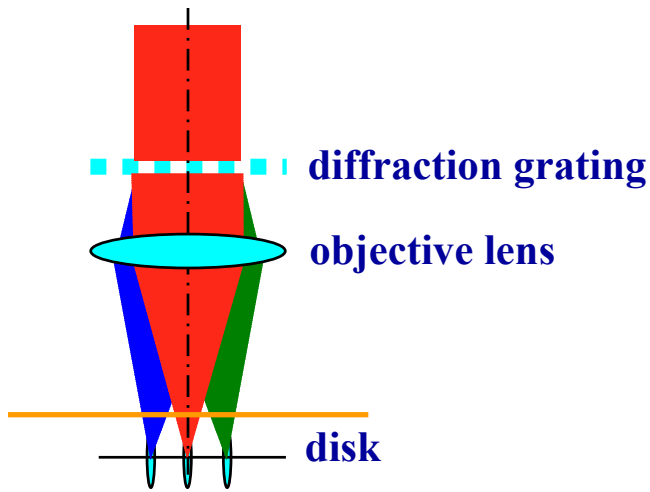




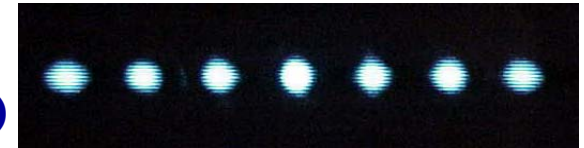
One Dimensional In-plane Parallel Readout



diffraction grating generates in-plane spot array.



Spot array
(power: $\pm 10\%$)



Parallel readout of 7 channels. (in-plane parallel readout)

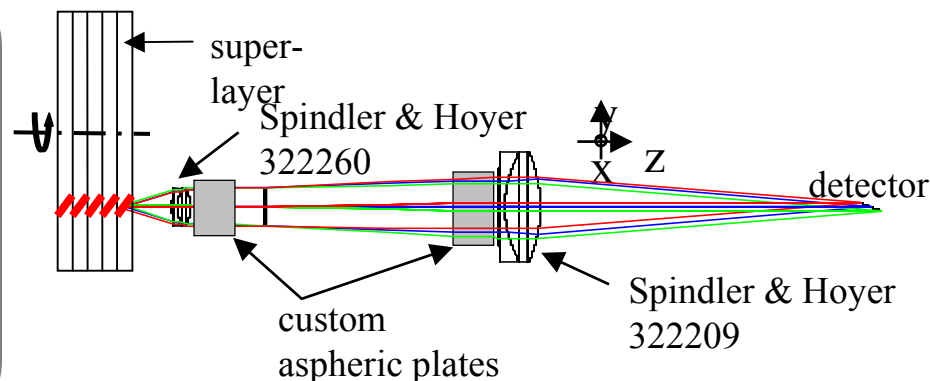


Depth Transfer Optics



OBJECTIVE

Collect fluorescent emission of 1000 data channels and image to detector array to achieve increased data throughput



APPROACH

- By using commercially available and custom optical components in a Depth Transfer Optical imaging system.
- multi-layer/multi-track parallel readout

3rd YEAR ACCOMPLISHMENTS

- Integration of components
- New 0.5 Optical system design with 120 μ m object field, 2.5x magnification.
- Standard cd/dvd voice coils for servo integrated in design.

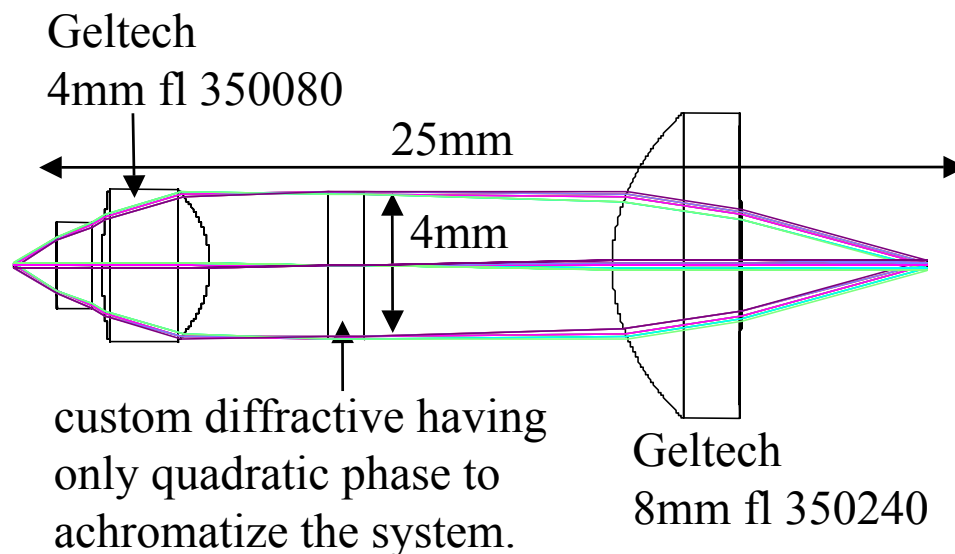
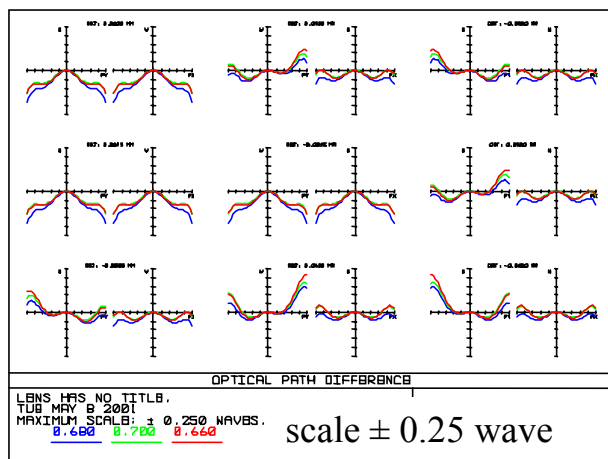


0.53 NA DTO design (incorporating commercially available and low cost custom components)



System properties

- NA = 0.53
- magnification $m = 2$
- Object field $120\mu\text{m}$
- initially corrected for $\sim 1.2\text{mm}$ of material thickness
- object to image distance $\sim 25\text{mm}$
- can accommodate up to $\sim 3\text{ mm}$ of disk thickness
- achromatic from $0.66\mu\text{m} - 0.7\mu\text{m}$



3D LAYOUT

LENS HAS NO TITLE,
TUB MAY B 2001

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CONFIGURATION 1 OF 1

- Higher performance than current 0.3NA design
- custom diffractive is manufacturable
- need to tolerance system
- shorter than previous system



MEMS FACT

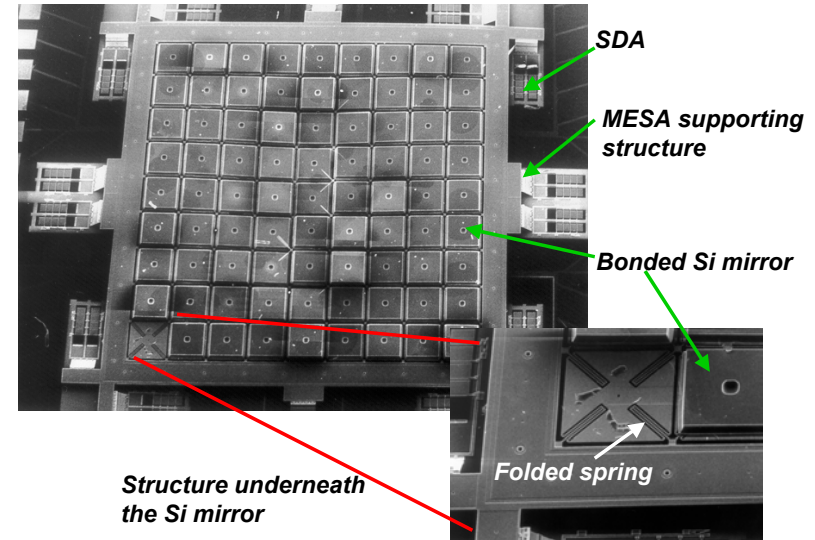


Fast Aberration Correction Technology

OBJECTIVE

Develop MEMS deformable mirrors for FROST to achieve

- Active control of focusing and tracking for optical pickup head
- Low cost and feasible MEMS Tip-tilt micromirror arrays (MTMA)



APPROACH

- By using commercial-available foundry service to fabricate low-cost prototype MEMS mirror arrays actuators
- Novel bonding process to transfer stress-free single crystalline silicon mirror onto MEMS actuators

3rd YEAR ACCOMPLISHMENTS

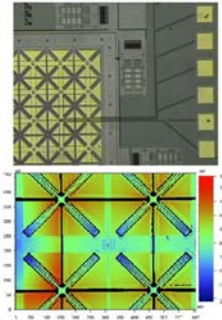
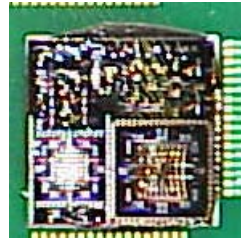
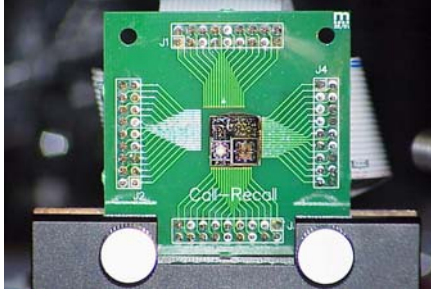
- Developed wafer-scale batch transfer process to fabricate smooth and flat mirror surface
- fabricated low cost MEMS deformable mirrors with long stroke ($\sim 10 \mu\text{m}$) and large aperture (3 mm)



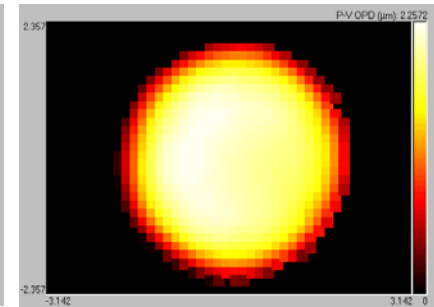
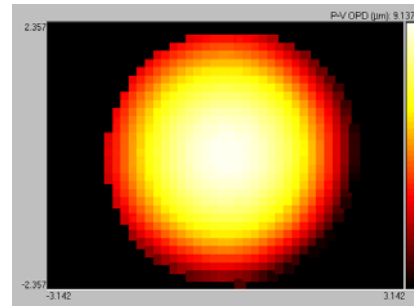
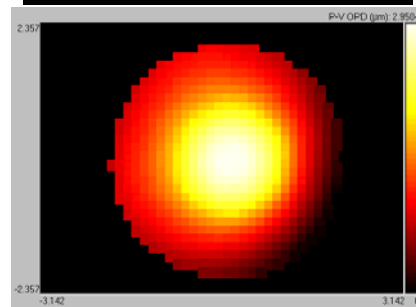
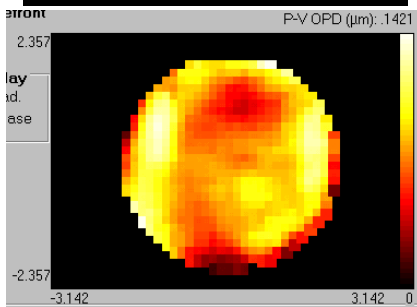
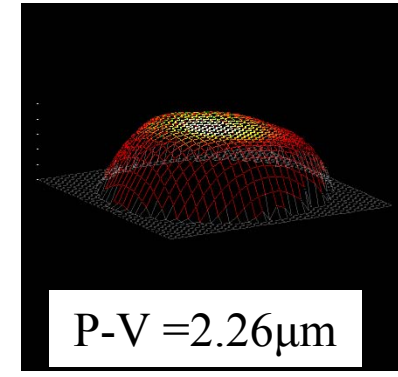
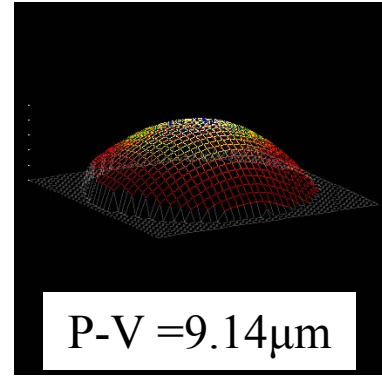
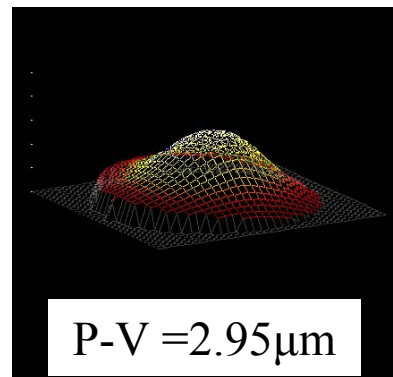
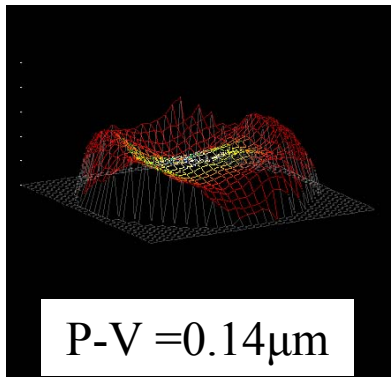
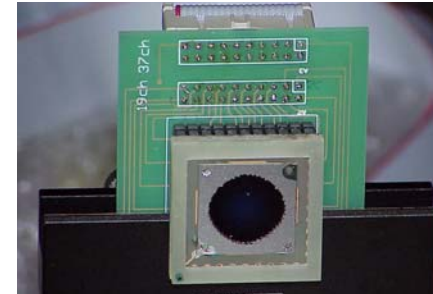
Optical testing of deformable mirror for aberration compensation



UCLA Mems mirror



OKO deformable mirror



- $9\mu\text{m}$ of defocus introduced on wavefront, resulting in $\sim 70\mu\text{m}$ of axial movement in 0.5NA system. $2\mu\text{m}$ of spherical aberration correction.

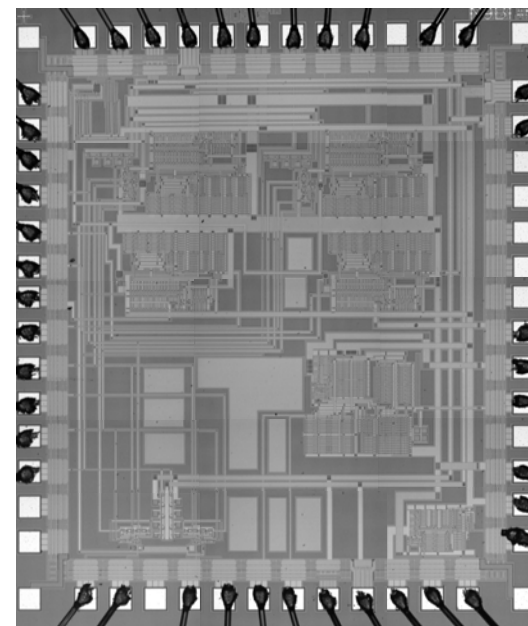
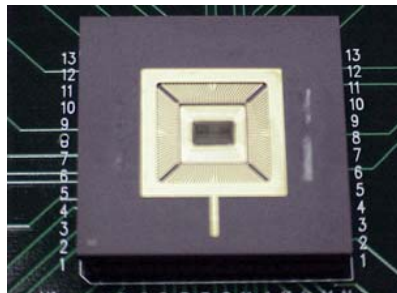
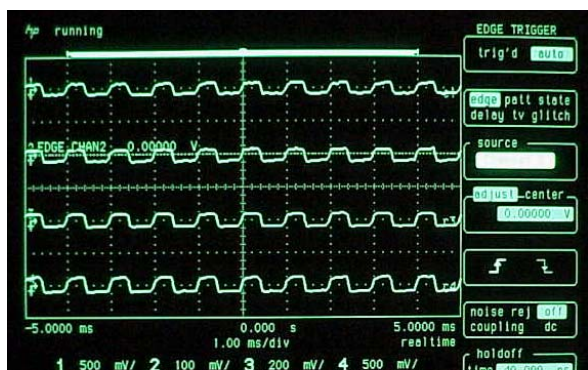


Low Light level Sensor array

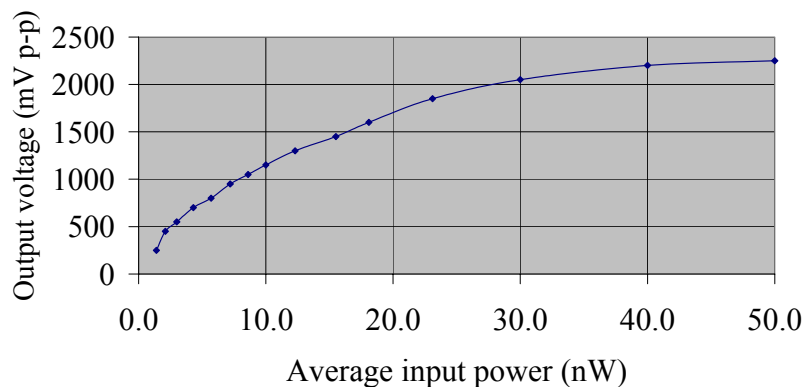


OBJECTIVE

Develop 5MHz hi sensitivity (3000 photons)
parallel detector array
(CMOS Active Pixel Sensor)



Continuous detector element



3rd YEAR ACCOMPLISHMENTS

- very low noise performance with ~2000 photon signals measured
- Test chip fabricated in MOSIS 0.5 μ m process and received from MOSIS
- Characterization of test chip



Servo



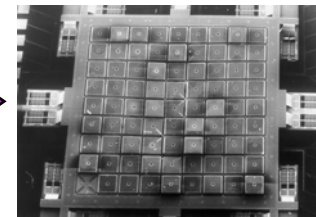
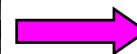
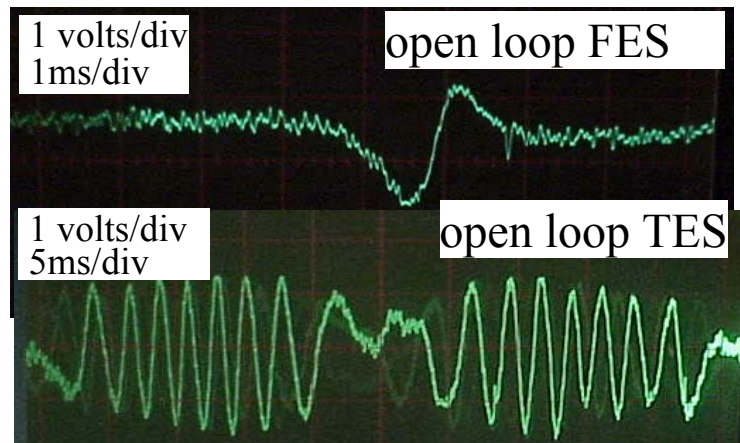
OBJECTIVE

Maintain the DTO and illumination beam position on the same page, super-layer/super-track addressing, maintain spindle speed

- for removable media
- for mechanical drift

3rd YEAR ACCOMPLISHMENTS

- closed-loop focus and tracking control developed for two-photon media.
- no preformatting of media required
- illumination and recording servo conceptualized and being developed.



APPROACH

- use standard voice-coil actuators.
- serial data channel
- then integrate MEMs devices
- extend to parallel data format



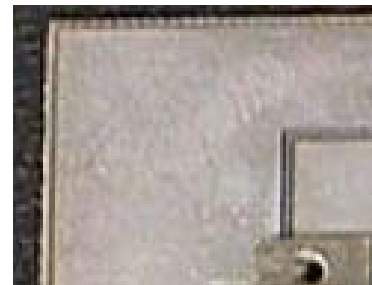
Read Channel Data Flow



OBJECTIVE

Decode 1024 parallel data channels

- Develop optimum encoding/decoding algorithms for parallel readout
- Optimize code for material characteristics



Dual Channel Decoder



COTS ECC chip

APPROACH

- By using commercial chips
- Small scale testing of low number of channels to aid in evaluating required performance.
- extend to 1024 channels

3rd YEAR ACCOMPLISHMENTS

- 16 channel readout system using programmable encoding/decoding
- Decoding System on an FPGA reconfigurable computing engine
- simulation tool to model ISI including detector, media, and DTO imaging system parameters.





FROST Year 3 accomplishments



- **Synthesized and characterized material with 3 times higher writing efficiency. Demonstrated that the material supports sub-micron size bits.**
- **Demonstrated a WORM system capable of 8 channel parallel readout with 8Mb/s readout speed.**
- **Demonstrated detectors on APS with fluorescence from disk media and measured sensitivity for 2000 photons.**
- **9x9 Mems mirror array from UCLA currently being integrated into DTO**
- **Serial closed-loop focus and tracking control optimized and extended to parallel channels.**
- **New Illumination and Depth Transfer Objective designs for thick media completed. Illumination beam of $20\mu\text{m} \times 160\mu\text{m} \times 300\mu\text{m}$ sheet of light demonstrated. 0.53NA Depth Transfer Objective with diffraction-limited performance across a $120\mu\text{m}$ object field designed.**



FROST Year 4 plan



- **Transition developed components into module and subsystem demonstrations.**
- **Demonstrate 4 x 16, 64 channel DTO readout system. (Next quarter)**
- **Design illumination beam and collection optics focus and tracking servo systems to handle 1024 parallel data channels.**
- **Submit a 1024(16 x64) active pixel sensor chip for fabrication**
- **Single track demo of 1024 parallel channels with 2Gb/s readout speed.**
- **Random access demonstration of a 50Gb capacity ROM disk with data transfer rates of 2Gb/s**
- **Packaging requirements will be continuously revised.**